Kingbright

3.2mmx3.6mm FULL-COLOR SURFACE MOUNT LED LAMP

PRELIMINARY SPEC

ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Part Number: APF3236SURKVGAPBA

Hyper Red
Green
Blue

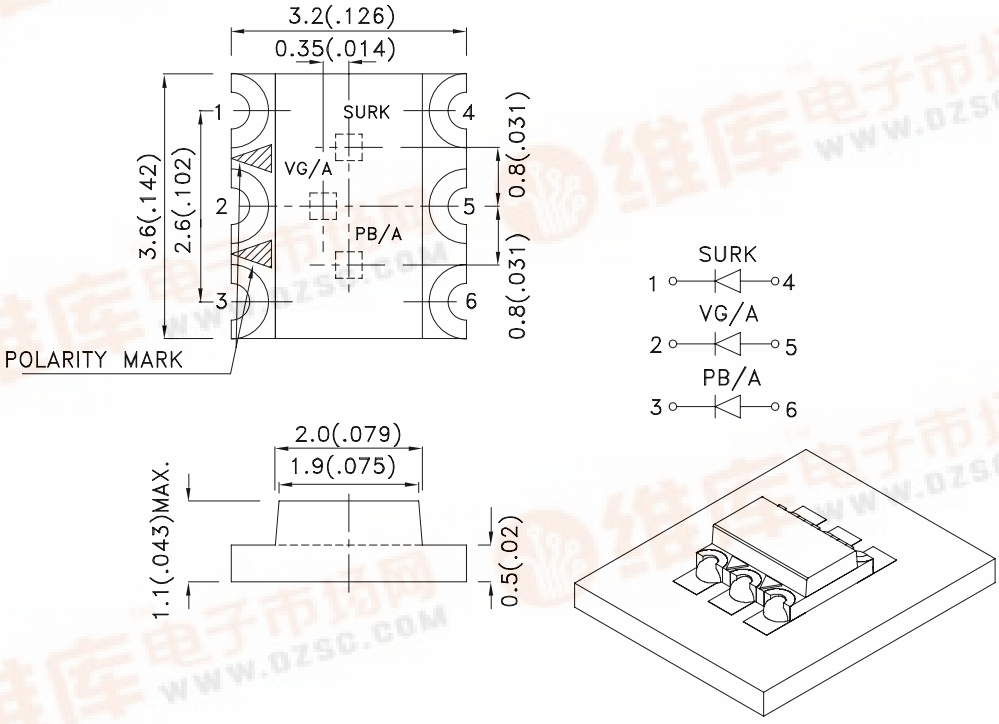
Features

- LOW POWER CONSUMPTION.
- 3.2mmx3.6mm SMT LED, 1.1mm THICKNESS.
- ONE RED, ONE GREEN AND ONE BLUE CHIPS IN ONE PACKAGE.
- CAN PRODUCE ANY COLOR IN VISIBLE SPECTRUM, INCLUDING WHITE LIGHT.
- PACKAGE : 1000PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 3.
- RoHS COMPLIANT

Description

The Hyper Red source color devices are made with DH InGaAlP on GaAs substrate Light Emitting Diode.
The Green source color devices are made with InGaN on G-SiC Light Emitting Diode.
The Blue source color devices are made with InGaN on SiC Light Emitting Diode.
Static electricity and surge damage the LEDS.
It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.
All devices, equipment and machinery must be electrically grounded.

Package Dimensions



Notes:
1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.2(0.008") unless otherwise noted.
3. Specifications are subject to change without notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Typ.	2θ1/2
APF3236SURKVGAPBA	Hyper Red (InGaAlP)	WATER CLEAR	70	150	120°
	Green (InGaN)		50	150	
	Blue (InGaN)		18	60	

Notes:
1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

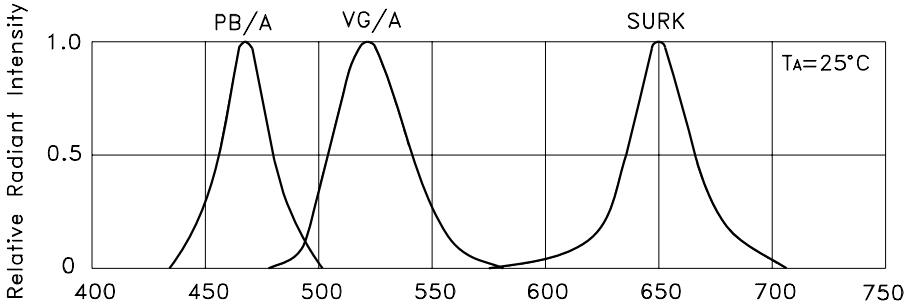
Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Green Blue	650 520 468		nm	I_F=20mA
λD [1]	Dominant Wavelength	Hyper Red Green Blue	635 525 470		nm	I_F=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Green Blue	28 35 21		nm	I_F=20mA
C	Capacitance	Hyper Red Green Blue	35 100 100		pF	V_F=0V;f=1MHz
V_F [2]	Forward Voltage	Hyper Red Green Blue	1.95 3.2 3.2	2.5 4 4	V	I_F=20mA
I_R	Reverse Current	Hyper Red Green Blue		10 10 10	uA	V_R=5V

Notes:
1.Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

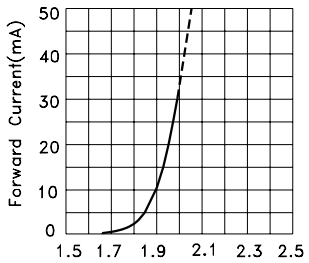
Parameter	Hyper Red	Green	Blue	Units
Power dissipation	75	120	120	mW
DC Forward Current	30	30	30	mA
Peak Forward Current [1]	185	100	100	mA
Reverse Voltage	5			V
Operating Temperature	-40°C To +85°C			
Storage Temperature	-40°C To +85°C			

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

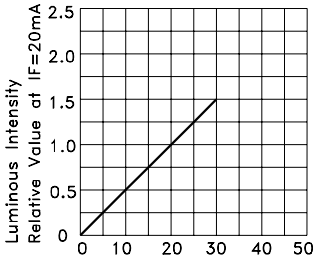


RELATIVE INTENSITY Vs. WAVELENGTH

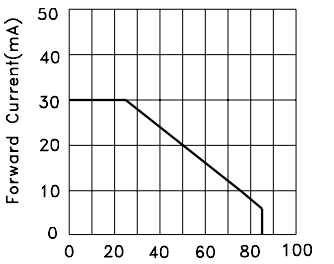
APF3236SURKVGAPBA
Hyper Red



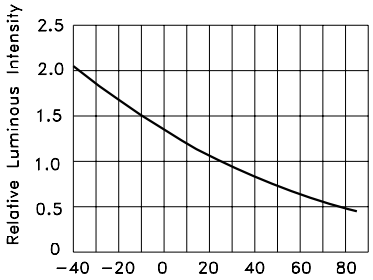
FORWARD CURRENT Vs.
FORWARD VOLTAGE



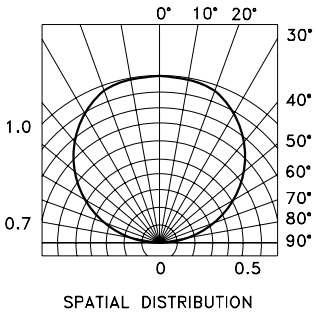
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE

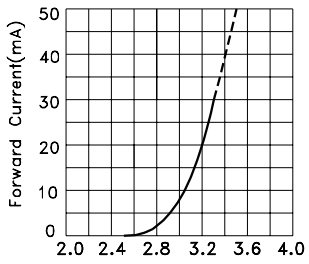


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE

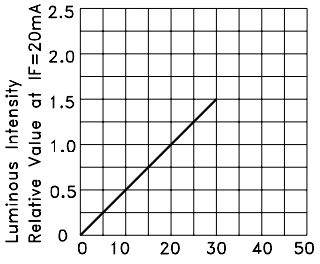


SPATIAL DISTRIBUTION

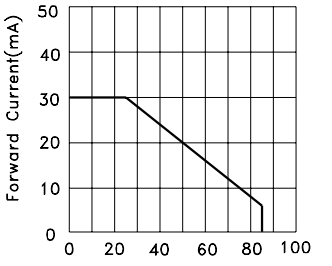
Green



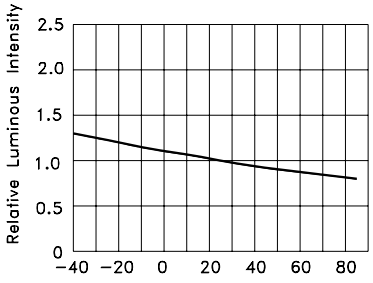
FORWARD CURRENT Vs.
FORWARD VOLTAGE



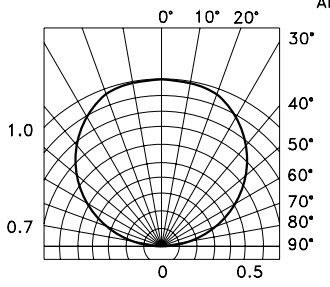
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE

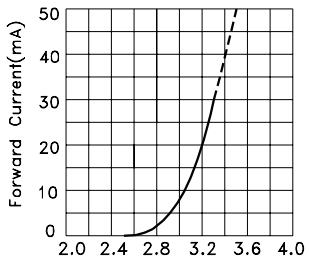


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE

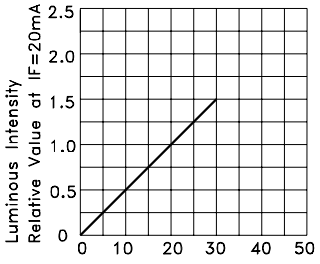


SPATIAL DISTRIBUTION

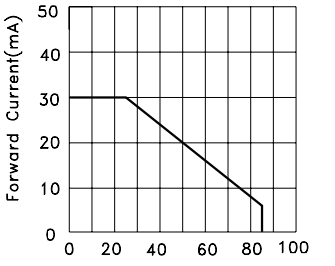
Blue



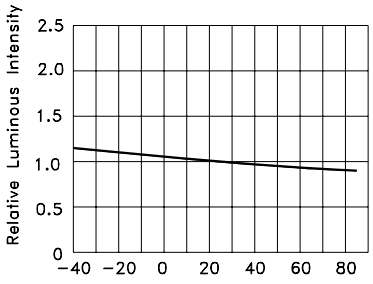
FORWARD CURRENT Vs.
FORWARD VOLTAGE



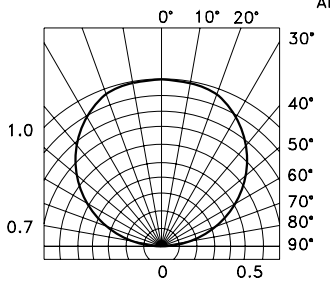
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE



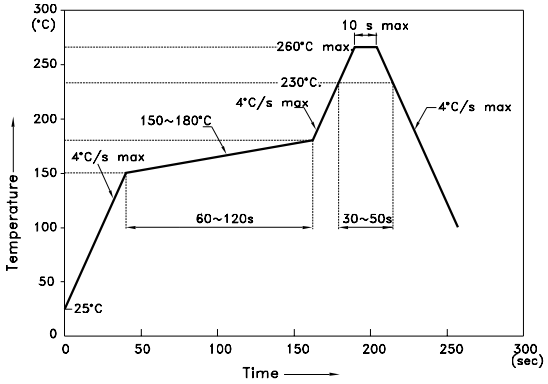
LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



SPATIAL DISTRIBUTION

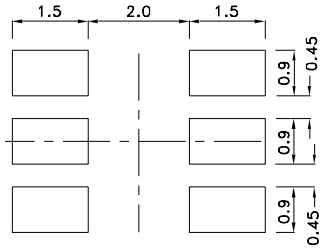
APF3236SURKVGAPBA

Reflow Soldering Profile For Lead-free SMT Process.

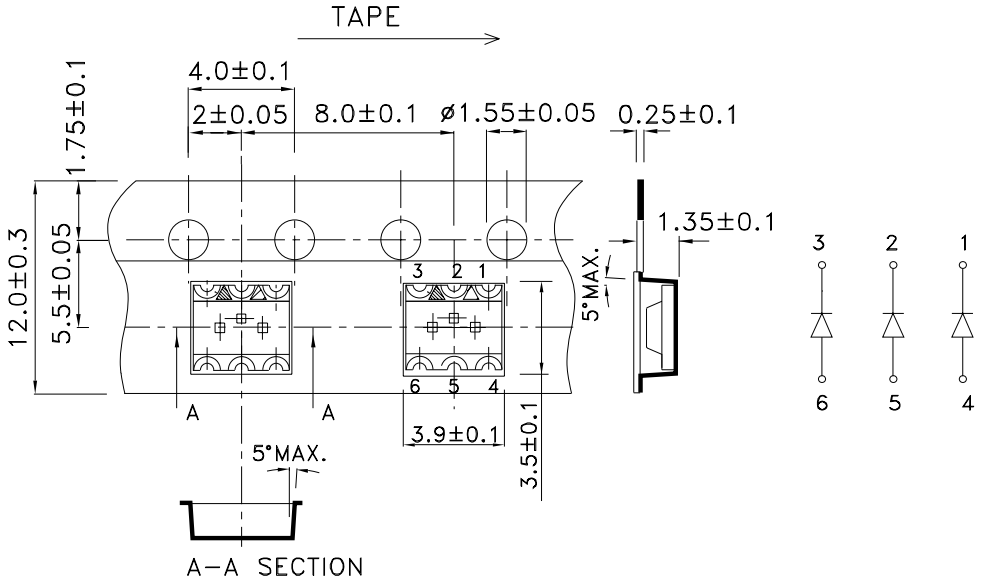


NOTES:
1. We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern
(Units : mm; Tolerance: ± 0.1)



Tape Specifications
(Units : mm)



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PACKING & LABEL SPECIFICATIONS **APF3236SURKVGAPBA**